Special Issue

Advances in Organic, Inorganic, and Organic/Inorganic Hybrid Composite Functional Materials Which Are High-Frequency and Low-Dielectric

Message from the Guest Editor

With the rapid development of electronic information technologies, such as high-frequency communication, artificial intelligence, and cloud computing, various types of low-k materials have been adopted to avoid the signal capacitance delay, crosstalk, and increased power consumption caused by metal resistance and parasitic capacitance between lines and layers. For example, organosilicates (fluorinated silicon glass (FSG or SiOF) and organosilicate glass (SiCOH), etc.) have been widely used for low-k interlayer dielectrics in integrated circuits (IC) packaging. Additionally, certain kinds of polymers (such as poly(arylene ether), polyimide, parylene-N/F, polytetrafluoroethylene, benzocyclobutene-based polymer, etc.) are commercially available for spin-on dielectric applications. Aside from material innovations, advanced chemical and physical structures of organic, inorganic, and hybrid low-k materials should be proposed to meet operation requirements, including outstanding mechanical property, good thermal stability, low shrinkage rate, low expansion coefficient, low water absorption, and good processability and surface smoothness.

Guest Editor

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Materials (ISSN 1996-1944) was launched in 2008. The journal covers twenty-five comprehensive topics: biomaterials, energy materials, advanced composites, advanced materials characterization, porous materials, manufacturing processes and systems, advanced nanomaterials and nanotechnology, smart materials, thin films and interfaces, catalytic materials, carbon materials, materials chemistry, materials physics, optics and photonics, corrosion, construction and building materials, materials simulation and design, electronic materials, advanced and functional ceramics and glasses, metals and alloys, soft matter, polymeric materials, quantum materials, mechanics of materials, green materials, general. Materials provides a unique opportunity to contribute high quality articles and to take advantage of its large readership.

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